Structual and thermoelectric properties of undoped IV-VI epitaxial films alloyed with tin

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Abstract

Iv-Vl-compounds are well known materials with favourable thermoelectric properties at elevated temperatures (-700 K) . Using related mixed crystals the thermoelectric properties can be optimised due to alloy scattering which leads to a decrease of the thermal conductivity without changing the other thermoelectric properties significantly. This method is well known as Joffe concept. The Joffe concept is about 50 years old and successfully proved several times using bulk crystals. But only few data exist about semiconductor thin fihns. Here we report on stuctural (SEM-, EDx-, XRD-, FT-IR-analysis) and in particular thermoelectric properties (Seebeck coefficient and Hall-Effect measuremenls for canier concentration, conductivity and mobility) of molecular beam epitaxy (MBE) grown thin film based on the "Joffe-systems" (Pb,Sn)Se and (Pb,Sn)Te. Special care was taken to evaluate the in-plane thermal conductivity of insulated free standing (Pb,Sn)Se thin films.

With increasing tin concentrations increasing charge carrier concentration as well as increasing thermopower values were observed. The bandgap decreased with increasing tin $concentration - shifting the optimum operating temperatures$ towards room temperature - and also the lattice thermal conductivity decreased as expected due to alloy scattering. All these effects strongly improve the thermoelectric properties of Sn-alloyed IV-VI epitaxial layers in the room temperatue region.

Introduction

For applications in the region of 300 K normally V-VI compounds based on solid solutions of $Bi₂Te₃$, $Bi₂Se₃$ and $Sb₂Te₃$ are used. Up to now these compounds show the highest figures of merit (FOM) and therefore have the best efficiencies in thermoelectric devices designed for room temperature use. A striking disadvantage of these V-Vlcompounds is the lamellar crystal structure leading to strong anisotropies of alrnost all physical properties relevant to thermoelectric (e.g. thermal and electric conductivity) and thin film growth (e.g. linear thermal expansion coefficient). These anisotropies complicate the use of V-VI compounds in thin film thermoelectric devices. Either the favourable properties of single crystalline films are found parallel or perpendicular to the substrate. Therefore - depending on the crystalline orientation of the substrates used to deposit epitaxial thin filrns - only applications exploiting in-plane (e.9. thermopiles) or cross-plane (e.g. Peltier coolers) will show optimum performance. In the case of a polycrystalline thin film the FOM will be determined by the distribution of the crystallographic orientations of the grains weighted with the respective thermoelectric properties in the direction of the respective driving force (temperature gradient for respective driving force (temperature thermogenerators or electric current for Peltier coolers). Although high FOM-values for V-VI-superlattices $[1]$ were reported up to now no devices exploiting these enhanced material properties are known. For the case of polycrystalline V-VI materials with an reduced average FOM miniaturized Peltier coolers [2] were successfully realized.

For IV-VI - based superlattices a high FOM has been reported by Harman [3], however no practical devices with this material are realised so far.

In contrast to the V-Vl-compounds IV-VI-based compounds possess the cubic NaCl-crystal structue and almost isotropic physical properties. Therefore in this material system polycrystalline thin films could be as good as $-$ or due to a reduced thermal conductivity because of grain boundary scattering even better than - polycrystalline V-VI thin films.

An epitaxial map (energy gap vs. laftice constant) of the lead salts compared to conmonly used substrate materials for lead chalcogenide epitaxial growth and possible ternary components is shown in figure 1.

Fig. l: Epitaxial map of the lead chalcogenides, possible ternary components and common substrate materials.

In the following the structural and thermoelectric properties of undoped epitaxial $Pb_{1-x}Sn_xSe$ and $Pb_{1-x}Sn_xTe$ thin films grown by MBE are be investigated.

IV-VI epitaxial thin filn growth and characterisation

The investigated films were grown in an EPI 930 MBE system equipped with a PbSe and a PbTe compound source, a tellurium source and a selenium cracker cell necessary io compensate the Se-- or Te-loss in the compound source. Prior to the growth 1 cm² BaF₂ substrates were freshly cleaved and fixed to the substrate holder using an InGa eutectic. In the load chamber the substrates were heated to 180° C for 18 minutes to remove water from the substrate surface. An additional thermal cleaning step (425 \degree C for 25 minutes) was done in the growth chamber. Then the substrates were cooled down to growth temperature of 370 °C (thermocouple reading). The flux ratios of the PbSe (PbTe) and Se (Te) were chosen as 10:1 to guarantee a sufficient stabilization. The growth rate was about 1.4μ m per hour.

X-ray diffractometry-measurements were used for the determination of lattice constants and Θ /2 Θ -scans are performed for phase analysis for the $Pb_{1-x}Sn_xSe$ -layers (figure 2). In Figure 3 the decrease of the lattice constant a_0 with increasing tin content in PbSnSe is shown.

Fig. 2: X-ray diffraction Θ /2 Θ -scan (Cu K_{α1}) of a $Pb_{0.94}Sn_{0.06}Se-film$ on a (111) BaF_2 substrate measured at Fraunhofer-lAF.

Fig. 3: Lattice constant a_0 and full width at half maximum (FWHM) of PbSnSe films on $BaF₂$ (111) at 300K determined by X-ray difftaction rneasurements versus Sn-content in comparison with literature data [15], [16].

After the growth the layers were investigated using Fourier transform inftared specfoscopy (FTIR) in order to determine the dependence of the absorption edge of the $Pb_{1-x}Sn_{x}Se$ and $Pb_{1,r}Sn_rTe$ layers on the tin concentration. Figure 4 shows measured infrared transmission spectra of the $Pb_{1-x}Sn_xSe$ layers and of an uncoated BaF_2 substrate. Besides the absorptions due to $BaF_2 \sim 700 \text{ cm}^{-1}$) the interference fringes with an almost equidistant spacing $dv = n \cdot d/2$ (n = refractive index, $d = film$ thickness) can be seen clearly. Knowing the refractive index of the thin film, the film thickness can thus be determined in principle from the FTIR spectrum. Since the reftactive index of the filrns depends on the Sn concentration the film thickness were determined by secondary electon microscopy (SEM) as shown in figure 5. Besides the film thickness also surface morphology was determined by SEM analysis. The Sn-concentration was investigated using EDX up to $±0.5$ at% accuracy. Using these Sn-contents the compositions of the samples were calculated.

wavenumber $[cm¹]$

Fig. 4: FTIR transmission spectra of $Pb_{1-x}Sn_xSe$ samples with different Sn concentrations and of an uncoated BaF₂ substrate.

Fig. 5: SEM measurement of a 4.16 μ m thick Pb_{1-x}Sn_xSe sample grown on a (111) BaF₂ substrate.

The thermopowers of the samples were measured at room temperature. During the measurement a temperature gradient of 10K was applied to generate the Seebeck voltage. The results are shown in figure 6. It is obvious, that the measued thermopower values decrease with increasing Sn-content.

The electrical conductivities and charge carrier concentrations
were determined by temperature dependent Hall were determined by temperature dependent Hall measurements using the van-der-Pauw method, The samples were thermally contacted to a cooled copper heat sink using silver glue, the electrical contacts were realized by gold wires soldered onto the corners of the samples using In-solder. During the measurement electrical currents in the region of *5 rnA and magnetic frelds of 0.2 Tesla were used. The measured mobilities and charge carrier concentrations in the terperature range from 40 K to 320 K are shown in figure 7a and b. With increasing Sn content the mobility at room temperature increases whereas the mobility rise towards lower temperatures decreases with increasing Sn content.

The measured charge carrier concentrations are almost temperature independent, with increasing Sn-content the concentration rises up to 4.10^{18} cm³ for PbSnSe (x = 0.08) and for PbSnTe (x = 0.12) up to 6.10^{18} cm⁻³.

Fig. 6: Room temperature thermopower values of the investigated Pb_1 , Sn, Se and Pb_1 , Sn, Te samples.

In order to conplete the thermoelectric properties, in-plane thermal conductivity measurements using a bridge method were performed on the PbSnSe samples. Details on the thermal conductivity measurements are given elsewhere [4], $[5]$.

Fig. 7: Temperature dependent mobilities (a) and charge carrier concentrations (b) \blacksquare Pb_{0.976}Sn_{0.043}Se; \bullet Pb_{0.976}Sn_{0.024}Se; Δ Pb_{0.979}Sn_{0.021}Se; ∇ Pb_{0.918}Sn_{0.082}Se; o Pb_{0.876}Sn_{0.124}Te; \circ Pb_{0.918}Sn_{0.082}Te; \triangle Pb_{0.986}Sn_{0.014}Te; ∇ Pb_{0.938}Sn_{0.062}Te

For the evaluation of the measurements an emissivity of the samples of $\varepsilon = 0.3$ – independent of the Sn content of the samples - was assumed. The resulting in-plane thermal conductivity values are shown in figure 8. Within the experimental error the total thermal conductivity λ decreases with increasing Sn content of the films.

Fig. 8: Measured in-plane thermal conductivities of the investigated $Pb_{1-x}Sn_xSe$ samples. [7], [8]

Results and discussion

The absorption edge of the investigated IV-VI-samples decreases with increasing Sn-content (Fig. 9). Although the determined absorption edges are not corrected for the Moss-Burstein-Shift [6] - which would qualitatively result in slightly lower energies at higher charge carrier concentrations - a good agreement with literature data $[9] - [13]$ can be found.

It is well known, that materials with a band gap of $E_g \sim 4 \cdot k_B \cdot T$ $(k_B: Boltzmann constant)$ are well suited for applications at a temperature T (e.g. Bi_2Te_3 : $E_g \sim 150$ meV ~ 6 · k_B ·300 K).

Therefore the decreased bandgap in the investigated Sn-rich samples should result in an enhanced room temperature thermoelectric efficiency. It is known, that for binary PbTe and PbSe epitaxial films the optimum charge carrier concentrations for high FOMs are in the region from 8.10^{18} cm⁻³ to 1.10^{19} cm⁻³. Since on the one hand side increasing Sn-contents result in increasing charge carrier concentrations and on the other hand increasing Sn-contents result in decreased band gaps, Sn has a double function in undoped lead chalcogenide films: It reduces the band gap and at the same time acts as a dopand. According to phase diagrams that can be found in the literature [14], [15] valid for crystals grown under equilibrium conditions p-type doping is found for Se (Te)-stabilized $Pb_{1-x}Sn_{x}Se$ ($Pb_{1-x}Sn_{x}Te$). The non-equilibrium MBE grown samples show n-type doping for Se-stabilized thin epitaxial films. The same effect was found for undoped, Te-stabilized $Pb_{1-x}Sn_xTe$ epitaxial films and confirmed by thermopower and Hall-measurements. Therefore the emplacement of Sn in our IV-VI compound thin films

grown under non-equilibrium conditions significantly differ from those single crystals.

Fig. 9: Energy of the absorption edge of $Pb_{1-x}Sn_xSe$ and Pb_1 . $x \text{Sn}_{x}$ Te samples respectively in comparison with literature data $[9] - [13]$

Using the experimentally determined charge carrier concentrations the electronic contribution λ_e of the thermal conductivity was determined under the assumption of parabolic energy bands. The effective masses m* used to calculate the reduced Fermi energies and Lorentz-numbers L were taken from [14]. The lattice thermal conductivities calculated by $\lambda_1 = \lambda - \lambda_e$ for the Pb_{1-x}Sn_xSe thin films are shown in figure 10. The effect of reduced λ_1 values due to alloy scattering is obvious. For the sample with the highest Sn content Pb_{0.92}Sn_{0.08}Se a lattice thermal conductivity of $\sim 1 \text{ Wm}^1 \text{K}^{-1}$ is found. Compared to the binary PbSe compounds with $\lambda_1 \sim 1.4 \text{ Wm}^{-1} \text{K}^{-1}$ this corresponds to a reduction of λ_1 by approximately 30 percent.

Fig. 10: Lattice thermal conductivities calculated from the measured total thermal conductivities by $\lambda_1 = \lambda - \lambda_e$.

The room temperature properties of the investigated "undoped" IV-VI epitaxial films alloyed with tin are summarized in table 1 and compared with other for high FOM optimised IV-VI thin films. Binary PbSe films with carrier concentrations optimised for room temperature $({\sim 1 \cdot 10^{19} \text{ cm}^{-3}})$ have $FOM < 0.3$. With increasing Sn content the FOM of the samples increases strongly even in these "undoped" samples. For $Pb_{0.918}Sn_{0.082}Se$ a very high value of $ZT = 0.6$ was determined.

A number of details are very promising that even higher FOMs can be realized within those unintentionally doped P_{1} . $_{x}$ Sn_xSe epitaxial films: Optimised FOMs are expected for carrier concentrations in the region of $1 \cdot 10^{19}$ cm⁻³. The experimental data presented indicate that these concentrations could be reached for $Pb_{0.825}Sn_{0.175}Se$ (s. table 1). For this compound a band gap of ~ 100 meV $\sim 4 \cdot k_B \cdot T$ – that means almost ideal for room temperature applications - is expected. The extrapolated Seebeck coefficient for this concentration is \sim 135 μ V/K. Finally due to the almost constant mobilities conductivities of $1400 \Omega^{-1}$ cm⁻¹ may be anticipated. Even though the lattice thermal conductivity is not reduced as much

as for low Sn contents in this region ZT values of 0.8 at 300 K are expected from the extrapolated data within the system of unintentionally doped epitaxial $Pb_{1-x}Sn_xSe$ thin films.

Similar results are expected for $Pb_{1-x}Sn_xTe$. The powerfactor for $Pb_{1,x}Sn_xTe$ is higher than that for $Pb_{1,x}Sn_xSe$ with a comparable tin content, but the thermal conductivity is to be higher too. Thermal conductivity expected measurements of the $Pb_{1-x}Sn_xTe$ films are in progress.

Further improvements of the FOM are expected with PbSnSe/PbSnSeTe or PbSnTe/PbSnSeTe-superlattices, similar to the results with PbSeTe-PbTe - SL[19] and PbTeSe-PbTe Quantum-Dot-SL [3].

Summary and outlook

It has been shown, that epitaxial $Pb_{1,x}Sn_{x}Se$ and Pb_{1} . "Sn. Te quasibinary films can reach thermoelectric figures of merit as high as 0.6 at room temperature. Main reason for this is the multifunctional effect of Sn in the thin film: Sn reduces the band gap towards values ideal for room temperature applications, Sn acts at the same time as a dopand increasing the charge carrier concentration towards 10^{19} cm⁻³ and last but not least reduces the thermal conductivity due to alloy scattering. The emplacement mechanisms for Sn in IV-VIbased compound non equilibrium MBE samples is not known up to now.

Extrapolating the presented results shows, that $ZT = 0.8$ could be reached within this system for $Pb_{0.825}Sn_{0.175}Se$ thin films. This value is still smaller than those known from standard Bi₂Te₃-based V-VI-compounds, nevertheless the expected isotropy of the $Pb_{1-x}Sn_xSe$ compounds could be a striking advantage. Due to isotropy such high $-$ or due to enhanced phonon scattering at grain boundaries – even higher FOMs should be found in polycrystalline materials. Therefore the complicated deposition of single crystalline compounds for the use in high efficient thin film thermoelectric devices could be overcome by the material system presented in this paper.

Table 1: Experimental data of $Pb_{1-x}Sn_xSe$ and $Pb_{1-x}Sn_xSe$ samples in comparison with literature data.

* optimised carrier concentration

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